

PCP1201 — NPN Epitaxial Planar Silicon Transistor High-Voltage Switching Applications

Applications

• DC / DC converter, relay drivers, lamp drivers, motor drivers, inverter.

Features

- · Adoption of FBET, MBIT process.
- High current capacitance.
- · Low collector-to-emitter saturation voltage.
- High-speed switching.
- High allowable power dissipation.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	VCBO		150	V
Collector-to-Emitter Voltage	VCES		150	V
Collector-to-Emitter Voltage	VCEO		120	V
Emitter-to-Base Voltage	VEBO		7	V
Collector Current	IC		2.5	А
Collector Current (Pulse)	ICP		4	А
Base Current	IB		500	mA
Collector Dissipation	PC	When mounted on ceramic substrate (450mm ² ×0.8mm)	1.3	W
		Tc=25°C	3.5	W
Junction Temperature	Tj		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Marking : QH

- Any and all SANYO Semiconductor Co.,Ltd. products described or contained herein are, with regard to "standard application", intended for the use as general electronics equipment (home appliances, AV equipment, communication device, office equipment, industrial equipment etc.). The products mentioned herein shall not be intended for use for any "special application" (medical equipment whose purpose is to sustain life, aerospace instrument, nuclear control device, burning appliances, transportation machine, traffic signal system, safety equipment etc.) that shall require extremely high level of reliability and can directly threaten human lives in case of failure or malfunction of the product or may cause harm to human bodies, nor shall they grant any guarantee thereof. If you should intend to use our products for applications outside the standard applications, please consult with us prior to the intended use. If there is no consultation or inquiry before the intended use, our customer shall be solely responsible for the use.
- Specifications of any and all SANYO Semiconductor Co.,Ltd. products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.

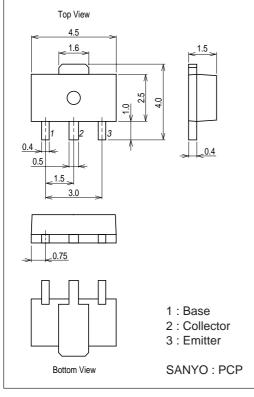
Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Linit
			min	typ	max	Unit
Collector Cutoff Current	ICBO	VCB=100V, IE=0A			1	μΑ
Emitter Cutoff Current	IEBO	V _{EB} =5V, I _C =0A			1	μΑ
DC Current Gain	hFE	V _{CE} =5V, I _C =100mA	200		560	
Gain-Bandwidth Product	fT	VCE=10V, IC=100mA		130		MHz
Output Capacitance	Cob	V _{CB} =10V, f=1MHz		13		pF
Collector-to-Emitter Saturation Voltage	V _{CE} (sat)	IC=1A, IB=100mA		100	150	mV
Base-to-Emitter Saturation Voltage	V _{BE} (sat)	IC=1A, IB=100mA		0.85	1.2	V
Collector-to-Base Breakdown Voltage	V(BR)CBO	I _C =10μA, I _E =0A	150			V
Collector-to-Emitter Breakdown Voltage	V(BR)CES	IC=100μA, RBE=0Ω	150			V
Collector-to-Emitter Breakdown Voltage	V(BR)CEO	IC=1mA, RBE=∞	120			V
Emitter-to-Base Breakdown Voltage	V(BR)EBO	IE=10μA, IC=0A	7			V
Turn-ON Time	ton	See specified Test Circuit.		50		ns
Storage Time	t _{stg}	See specified Test Circuit.		1250		ns
Fall Time	tf	See specified Test Circuit.		60		ns

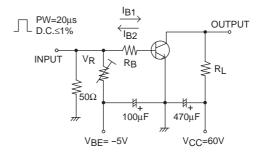
Package Dimensions

unit : mm (typ)

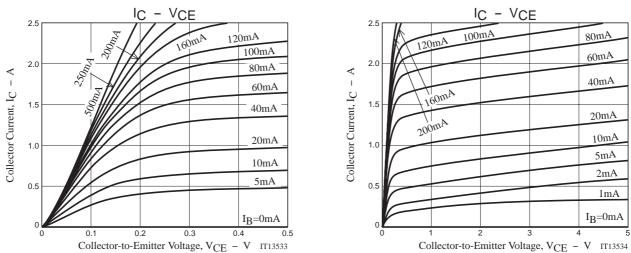
7008A-003

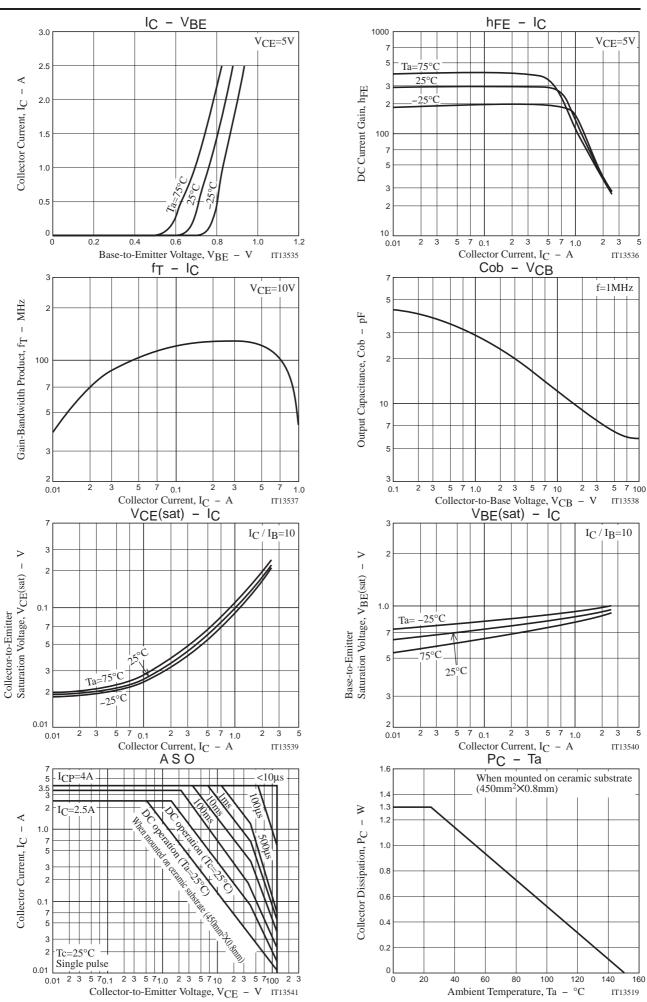


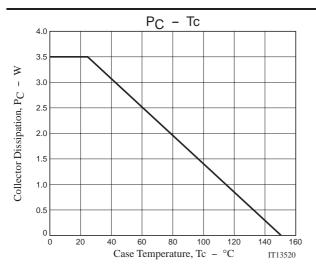
Switching Time Test Circuit



 $I_{C}=10I_{B1}=-10I_{B2}=0.5A$







- SANYO Semiconductor Co.,Ltd. assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all SANYO Semiconductor Co.,Ltd. products described or contained herein.
- SANYO Semiconductor Co.,Ltd. strives to supply high-quality high-reliability products, however, any and all semiconductor products fail or malfunction with some probability. It is possible that these probabilistic failures or malfunction could give rise to accidents or events that could endanger human lives, trouble that could give rise to smoke or fire, or accidents that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all SANYO Semiconductor Co.,Ltd. products described or contained herein are controlled under any of applicable local export control laws and regulations, such products may require the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written consent of SANYO Semiconductor Co.,Ltd.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the SANYO Semiconductor Co.,Ltd. product that you intend to use.
- Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production.
- Upon using the technical information or products described herein, neither warranty nor license shall be granted with regard to intellectual property rights or any other rights of SANYO Semiconductor Co.,Ltd. or any third party. SANYO Semiconductor Co.,Ltd. shall not be liable for any claim or suits with regard to a third party's intellectual property rights which has resulted from the use of the technical information and products mentioned above.

This catalog provides information as of July, 2008. Specifications and information herein are subject to change without notice.